# Chapter 2 Single-node Architecture

## Outline

- 2.1. Sensor Node Architecture
- ▶ 2.2. Introduction of Sensor Hardware Platform
- ▶ 2.3. Energy Consumption of Sensor Node
- > 2.4. Network Architecture
- ▶ 2.5. Challenges of Sensor Nodes
- > 2.6. Summary

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# 2.1. Sensor Node Architecture

# Main Architecture of Sensor Node

- The main architecture of sensor node includes following components:
  - Controller module
  - Memory module
  - Communication module
  - Sensing modules
  - Power supply module



# Main Components of a Sensor Node : Controller module

- Main options:
  - MCUs (Microcontrollers)
    - The processor for general purposes
    - Optimized for embedded applications
    - Low energy consumption
  - DSPs (Digital Signal Processors)
    - Optimized for signal processing
    - Low cost
    - High processing speed
    - Not suitable for sensor node
  - ► FPGAs (Field Programmable Gate Arrays)
    - Suitable for product development and testing
    - Cost higher than DSPs
    - High energy consumption
    - Processing speed lower than ASICs
  - ASICs (Application-Specific Integrated Circuits)
    - Only when peak performance is needed
    - For special purpose
    - Not flexable

# Main Components of a Sensor Node : Controller module

## • Example of microcontrollers are recently used in Senor Node

- ATMega128L, Atmel
  - 8-bit controller
  - ▶ 128KB program memory (flash)
  - ▶ 512KB additional data flash memory
  - larger memory than MSP430
  - slower
- MSP430, TI (Texas Instruments)
  - ► 16-bit RISC core
  - ► 8MHz
  - ► 48KB Flash
  - ▶ 10KB RAM
  - several DACs
  - ► RT clock
- ▶ 8051 in CC2430 & CC2431, TI (Texas Instruments)
  - ▶ 8-bit MCU
  - ▶ 32/64/128 KB program memory
  - ► 8 KB RAM
  - ► 21I/O

- The communication module of a sensor node is called "Radio Transceiver"
- The essentially tasks of transceiver is to "transmit" and "receive" data between a pair of nodes
- Which characteristics of the transceiver should be consider for sensor nodes?
  - Capabilities
  - Energy characteristics
  - Radio performance

- Transceiver characteristics
  - Capabilities
    - Interface to upper layers (most notably to the MAC layer)
      bit, byte or packet?
    - Supported frequency range?
      - □ Typically, somewhere in 433 MHz 2.4 GHz, ISM band
    - Supported multiple channels?
    - Transmission data rates?
    - Communication range?

## Transceiver characteristics

- Energy characteristics
  - Power consumption to send/receive data?
  - Time and energy consumption to change between different states?
  - Supported transmission power control?
  - Power efficiency (which percentage of consumed power is radiated?)

- Radio performance
  - Modulation?
    - $\Box$  ASK, FSK, PSK, QPSK...
  - Noise figure?
  - Gain?
  - Carrier sensing and RSSI characteristics
  - Frequency stability (Ex: towards temperature changes)
  - Voltage range

## Transceivers typically has several different states/modes :

- Transmit mode
  - Transmitting data
- **Receive** mode
  - Receiving data
- Idle mode
  - Ready to receive, but not doing so
  - Some functions in hardware can be switched off
  - Reducing energy consumption a little
- Sleep mode
  - Significant parts of the transceiver are switched off
  - Not able to immediately receive something
  - Recovery time and startup energy to leave sleep state can be significant

- Example of transceivers are recently used in Senor Node
  - RFM TR1000 family
    - 916 or 868 MHz
    - ▶ 400 kHz bandwidth
    - Up to 115,2 kbps
    - On/off keying or ASK
    - Dynamically tuneable output power
    - Maximum power about 1.4 mW
    - Low power consumption
  - Chipcon CC1000
    - Range 300 to 1000 MHz, programmable in 250 Hz steps
    - FSK modulation
    - Provides RSSI

- Chipcon CC 2400
  - Ex: TI CC2420
  - Implements 802.15.4
  - > 2.4 GHz, DSSS modem
  - ▶ 250 kbps
  - Higher power consumption than above transceivers
- ► Infineon TDA 525x family
  - E.g., 5250: 868 MHz
  - ASK or FSK modulation
  - RSSI, highly efficient power amplifier
  - Intelligent power down, "selfpolling" mechanism
  - Excellent blocking performance

## • TI CC 2431

- ▶ 8051 MCU core
- ▶ 128KB in-system programmable flash
- ▶ 8KB RAM, 4KB with data retention in all power mode
- Powerful DMA
- One IEEE 802.15.4 MAC timer
- > 2.4GHz IEEE 802.15.4 compliant RF
- RX (27mA), TX (27mA), MCU running at 32MHz
- 0.5uA current consumption in powerdown mode
- 0.3uA current consumption in stand-by mode
- Wide supply voltage range (2.0V-3.6V)
- CSMA/CA hardware support
- Digital RSSI/LQI support
- ▶ 12-bit ADC with up to eight inputs and configuration resolution
- Two USARTs with support for several serial protocols

# Main Components of a Sensor Node : Sensing module

## Sensor's main categories [1]

- Passive vs. Active
- Directional vs. Omidirectional

## Some sensor examples

- Passive, omnidirectional
  - ▶ light, thermometer, microphones, hygrometer, ...
- Passive, directional
  - electronic compass, gyroscope, ...
- Passive, narrow-beam
  - ▶ CCD Camera, triple axis accelerometer, infrared sensor ...
- Active sensors
  - ▶ Radar, Ultrasonic, ...

# Main Components of a Sensor Node : Sensing module

## • Example of sensors are integrated with Senor Node



Infar sensor



Ultrasonic



Gyroscope



Electronic compass



#### Pressure Sensor



Triple axis accelerometer



Temperature and Humidity Sensor

# Main Components of a Sensor Node : Power supply module

## Power supply module

- Provides as much energy as possible and includes following requirements
  - Longevity (long shelf live)
  - Low self-discharge
  - Voltage stability
  - Smallest cost
  - High capacity/volume
  - Efficient recharging at low current
  - Shorter recharge time

## Options of power supply module

- Primary batteries
  - not rechargeable
- Secondary batteries
  - rechargeable
  - In WSN, recharging may or may not be an option

# Main Components of a Sensor Node : Memory module

- > The memory module of a sensor node has two major tasks
  - To store intermediate sensor readings, packets from other nodes, and so on.
  - To store program code

## For the first task

- Random Access Memory (RAM) is suitable
- The advantage of RAM is fast
- The main disadvantage is that it loses its content if power supply is interrupted

# Main Components of a Sensor Node : Memory module

## For the second task

- Read-Only Memory (ROM)
- Electrically Erasable Programmable Read-Only Memory (EEPROM)
- Flash memory (allowing data to be erased or written in blocks)
  - can also serve as intermediate storage of data in case RAM is insufficient or when the power supply of RAM should be shut down for some time
  - long read and write access delays
  - high required energy

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# 2.2. Introduction of Sensor Hardware Platform

# Overview of Sensor Node Platforms

- Some modules developed by U.C. Berkeley & Crossbow Tech.
  - MICA2
    - 8-bit Atmel ATmega128L microcontroller
    - (4 KB SRAM + 128 KB Flash)
    - RF: CC1000 (data rate: 38.4kbits/s)
  - MICAz
    - 8-bit Atmel ATmega128L microcontroller
    - RF: CC2420 (data rate: 250kbits/s)
  - TelosB
    - ▶ 16-bit MSP430 microcontroller
    - (10 KB RAM + 48KB Flash) + 1MB Flash
    - RF: CC2420 (data rate: 250kbits/s)
  - IRIS
    - 8-bit Atmel ATmega1281 microcontroller
    - (8 KB RAM + 128KB Flash) + 512KB Flash
    - RF: RF230, data rate: 250kbits/s



# Overview of Sensor Node Platforms

- Octopus modules were developed by NTHU
  - Octopus I (Compatible with MICAz)
    - 8-bit Atmel ATmega128L microcontroller
    - RF: CC2420 (data rate: 250kbits/s)
  - Octopus II
    - 16-bit MSP430 microcontroller
    - 10 KB RAM + 48KB Flash) + 1MB Flash
    - RF: CC2420 (data rate: 250kbits/s)
  - Octopus X
    - ▶ 8-bit 8051 microcontroller
    - ▶ 128KB in-system programmable flash
    - ▶ 8KB RAM + 4KB EEPROM
    - ▶ RF: CC2430, EEE 802.15.4 compliant RF transceiver



Octopus I



Octopus II



Octopus X

## Octopus X includes three models

- Octopus X-A
  - CC2431 + Inverted F Antenna
- Octopus X-B
  - CC2431 + SMA Type Antenna
- Octopus X-C





Octopus X-A Octopus X-B

Octopus X-C

- CC2431 + Inverted F and SMA Type Antenna + USB interface
- Peripherals of Octopus X
  - Octopus X-USB dongle
  - Octopus X-Sensor board
    - Temperature sensor
    - Gyroscope
    - Three axis accelerometer
    - Electronic Compass



Three axis accelerometer



Octopus X-C (57mm × 31mm)

# Features of Octopus X-A



- MCU (CC2431)
- Inverted-F antenna
- RF transmission range  $\Rightarrow$  100m
- External crystal (32MHz+32.768KHz)
  - 30-Pin expansion connector
  - Polymer batter (3.7V 300mAh)



# Features of Octopus X-B



- MCU (CC2431)
- SMA type antenna
- RF transmission range  $\Rightarrow$  150m
- External crystal (32MHz+32.768KHz)
- 30-Pin expansion connector
- Polymer batter (3.7V 300mAh)

# Features of Octopus X-C

#### Size: 57mm × 31mm



MCU (CC2431)

- ► SMA type and Inverted-F antenna
- Humidity & Temperature sensor
  - Humidity 0~100%RH (0.03%RH)
  - ► Temperature -40°C~120°C (0.01°C)
- External flash memory (2MB)
- MicroSD socket (up to 8GB)
- USB Interface
  - Programming
  - Debugging
  - Data collection

# Features of Octopus X - USB Dongle

# USB Dongle

- Octopus X-USB dongle provides an easy-to-use USB protocol for
  - Programming
  - Debugging
  - Data collections

## Features of Octopus X - Sensor Boards

Size: 28mm × 18mm



Front view of Octopus X-sensor board



Electronic Compass

Back view of Octopus X-sensor board



Sensor board (Gyroscope + Triple axis accelerometer)

# Features of Octopus X - Dock

#### Size: 60mm × 71mm



- USB interface
  - Programming with our flash programmer
  - Data collections
- Debug interface
  - Programming with TI SmartRF04EB
- ► 30-Pin expansion connector
- User switch and reset switch
- Test points
- DC power switch
- ► 3 LEDs

# Summary of Octopus X

- Octopus X is not only compatible with IAR embedded workbench but also "Keil C " software
- Octopus X is of 2-Layer design to reduce production cost
- Octopus X can be not only programmed from USB interface but also TI programming board
- RF transmission range of Octopus X is up to 150m
- Expansion connector design on Octopus X provides a user interface for sensor boards and dock

- Octopus II includes two models
  - Octopus II-A
    - MSP430F1611 + USB Interface + Inverted F and SMA Type Antenna
  - Octopus II-B
    - Octopus II-A + External Power Amplifier
- Peripherals of Octopus II
  - Octopus II-Sensor board
    - Temperature sensor
    - Light sensors
    - Gyroscope
    - Three axis accelerometer







Octopus II-B



Octopus II-Sensor board



Sensor Board Size: 50mm × 31mm





## Octopus II block diagram





# Features of Octopus II-A

- MCU (MSP430F1611)
  - Flash Memory (48 KB + 256 KB)
  - RAM (10 KB)
  - External Flash (1 MB)
  - External Crystal (4 MHz + 32.768 KHz)
  - ► Serial Communication Interface (USART, SPI or I<sup>2</sup>C)
  - Low Supply-Voltage Range (1.8V ~ 3.6V)
  - Five Power-Saving Modes

### Sensors

- Humidity & Temperature sensor
  - Humidity 0 ~ 100%RH (0.03%RH)
  - Temperature  $-40^{\circ}C \sim 120^{\circ}C (0.01^{\circ}C)$
- Light sensors

# Features of Octopus II-A

## Radio (CC2420)

- > 2.4GHz IEEE 802.15.4 compliant RF
- Data rate (250 Kbps)
- Rx (18.8 mA), Tx (17.4 mA)
- Programmable output power
- Digital RSSI/LQI support
- Hardware MAC encryption
- Battery monitor
- RF transmission range  $\approx 250$ m

## Serial number ID

- ► 50-Pin expansion connector
- External DC power connector
## Features of Octopus II-A

#### Front view of Octopus II-A

Size: 65mm × 31mm



## Features of Octopus II-A

Back view of Octopus II-A



## Features of Octopus II-B

Size: 80mm × 31mm





- RF transmission range  $\Rightarrow$  450m
- CC2420 with external power amplifier
- Maximum output power: ~10dBm
- Compliance with IEEE 802.15.4 (ZigBee)

## Features of Octopus II - Sensor board

#### Size: 50mm × 31mm





#### Sensors

- Humidity & Temperature sensor
  - Humidity 0-100%RH (0.03%RH)
  - Temperature  $-40^{\circ}C \sim 120^{\circ}C (0.01^{\circ}C)$
- Light sensors
- **Gyroscope** 
  - Integrated X and Y-axis gyro
- Three axis accelerometer
  - ► Selectable sensitivity (1.5g/2g/4g/6g)
  - Low current consumption (600uA)
  - Sleep mode (3uA)
  - ► Low voltage operation (2.2V-3.6V)
  - High sensitivity (800mV/g @ 1.5g)

## Features of Octopus II - Dock

Size: 90mm × 54mm



- Easy-to-develop WSN applications
- Debug interface
  - Programming with TI flash programmer
- DC power input
- Power switch
- 3 power LEDs
- 4 user LEDs
- User switch and reset switch
- ▶ 2 row expansion connectors

## Summary of Octopus II

- Octopus II is not only compatible with TinyOS but also standard C programming
- Octopus II is of 2-Layer design to reduce production cost
- Octopus II can be programmed from USB interface
- Octopus II has two kinds of antennas, SMA type and inverted F type
- RF transmission range of Octopus II is up to 450m
- Expansion connector design on Octopus II provides a user interface for sensor boards and dock

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# 2.3. Energy Consumption of Sensor Node

## The Main Consumers of Energy

Microcontroller

## Radio front ends

- RF transceiver IC
- ► RF antenna

#### Degree of Memory

- ► RAM
- EEPROM
- Flash memory

#### Depending on the type of sensors

- Temperature sensor
- Humidity sensor

#### • Other components

- ► LED
- External Crystal
- USB IC

## Energy consumption of Microcontroller

- A "back of the envelope" estimation for energy consumption
  - It means "energy consumption" is easily to estimate

#### Number of instructions

- Energy per instruction: 1 nJ [4]
- Small battery ("smart dust"): 1 J = 1 Ws
- Corresponds: 10<sup>9</sup> instructions!

#### Lifetime

- Require a single day operational lifetime =  $24hr \times 60mins \times 60secs = 86400 secs$
- 1 Ws / 86400s  $\approx$  11.5  $\mu$ W as max. sustained power consumption!

#### Not feasible!

- Most of the time a wireless sensor node has nothing to do
- Hence, it is best to turn it off

## Multiple power consumption modes

#### • Way out: Do not run sensor node at full operation all the time

- If nothing to do, switch to *power safe mode*
- Question: When to throttle down? How to wake up again?

### Typical modes

- Microcontroller
  - Active, Idle, Sleep
- Radio mode
  - Turn on/off transmitter/receiver or Both
- Multiple modes possible, "deeper" sleep modes
  - Strongly depends on hardware
  - Ex: TI MSP 430
    - Four different sleep modes
  - Atmel ATMega
    - Six different modes

## Some Energy Consumption Figures

- Microcontroller power consumption
  - TI MSP 430 (@ 1 MHz, 3V) [6]
    - Fully operation : 1.2 mW
    - Deepest sleep mode :  $0.3 \,\mu W$ 
      - Only woken up by external interrupts (not even timer is running any more)
  - Atmel ATMega128L [7]
    - Operational mode:
      - $\Box$  Active : 15 mW
      - $\Box$  Idle : 6 mW
    - Sleep mode :  $75 \mu W$

## Some Energy Consumption Figures

- TI CC2430[8] & 2431 [9]
  - MCU Active Mode, static : 492  $\mu$ A
    - $\square$  No radio, crystals, or peripherals
  - MCU Active Mode, dynamic : 210µA/MHz
    □ No radio, crystals, or peripherals
  - MCU Active Mode, highest speed : 7.0 mA
    - $\square$  MCU running at full speed (32MHz)
    - $\square$  No peripherals
  - Power mode  $1:296\mu A$ 
    - □ RAM retention
  - Power mode 2 : 0.9 µA
    □ RAM retention
  - Power mode 3: 0.6µA
    □ No clocks, RAM retention

## Some Energy Consumption Figures

#### Memory power consumption

- Power for RAM almost negligible
- FLASH memory is crucial part
- FLASH writing/erasing is expensive
  - Example: FLASH on Mica motes
  - Reading:  $\doteq 1.1 \ nAh$  per byte
  - Writing:  $\Rightarrow$  83.3 *nAh* per byte

## Switching between Modes

- Simplest idea: Greedily switch to lower mode whenever possible
- Problem: Time and power consumption required to reach higher modes not negligible
  - Introduces overhead
  - Switching only pays off if  $E_{\text{saved}} > E_{\text{overhead}}$
- Example:
  - Event-triggered wake up from sleep mode
- Scheduling problem with uncertainty



## Switching between Modes

• 
$$E_{\text{saved}} = (t_{\text{event}} - t_1) \times P_{\text{active}} - (\tau_{\text{down}} \times (P_{\text{active}} + P_{\text{sleep}})/2 + (t_{\text{event}} - t_1 - \tau_{\text{down}}) \times P_{\text{sleep}})$$

$$E_{\text{overhead}} = \tau_{\text{up}} \times (P_{\text{active}} + P_{\text{sleep}}) / 2$$



## Power Consumption vs. Transmission Distance

Free space loss: direct-path signal

$$P_{r} = P_{t}G_{r}G_{t} \frac{\lambda^{2}}{(4\pi)^{2}(d)^{2}} = P_{t} \frac{A_{r}A_{t}}{(\lambda d)^{2}}$$

- d = distance between transmitter and receiver
- $P_t$  = transmitting power
- $P_r$  = receiving power
- $G_t$  = gain of transmitting antenna
- $G_{\rm r}$  = gain of receiving antenna
- $A_t$  = effective area of transmitting antenna
- $A_r$  = effective area of receiving antenna

Power Consumption vs. Transmission Distance

Two-path model

$$P_r = P_t G_r G_t \left(\frac{h_t h_r}{d^2}\right)^2$$

- $h_t$  and  $h_r$  are the height of the transmitter and receiver
- The general form

$$P_r = P_t G_r G_t \left(\frac{\lambda}{4\pi}\right)^2 \frac{1}{d^{\gamma}}$$

>  $\gamma$  is the propagation coefficient that varies 2 ~ 5

## Computation vs. Communication Energy Cost

### Tradeoff ?

- It's not possible to directly compare computation/communication energy cost
- Energy ratio of "sending one bit" vs. "computing one instruction"
- Communicate (send & receive) 1 KB ≒ Computing 3,000,000 (3 million) instructions [10]

#### Hence

Try to compute instead of communicate whenever possible

#### Key technique in WSN

- In-network processing
- Exploit data centric/aggregation, data compression, intelligent coding, signal processing ...

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# 2.4. Network Architecture

## Difference between Ad hoc and Sensor Networks

- (Mobile) Ad hoc Scenarios
  - Nodes communicate with each other
    - That means each node can be a source node or destination node
  - Nodes can communicate "some" node in another network
    - Ex: Access to Web/Mail/DNS server on the Internet
    - Typically requires some connection to the fixed network
- Applications of Ad hoc networks
  - Traditional data (http, ftp, collaborative apps, ...)
  - Multimedia (voice, video)

## Difference between Ad hoc and Sensor Networks

#### (Mobile) Ad hoc Scenarios



Ad hoc network

## Difference between Ad hoc and Sensor Networks

- Sensor Network Scenarios
  - **Sources**: Any sensor node that provides sensing data/measurements
  - **Sinks**: Sensor nodes where information is required
    - Belongs to the sensor network
    - Could be the same sensor node or an external entity such PDA/NB/Table PC
    - Is part of an external network (e.g., internet), somehow connected to the WSN
- Applications of Sensor Network
  - Usually, machine to machine
  - Often limited amounts of data
  - Different notions of importance

## Difference between Ad hoc and Sensor Network

#### Sensor Network Scenarios





## Single-hop vs. Multi-hop Networks

#### • One common problem: limited range of wireless communication

- Limited transmission power
- Path loss
- Obstacles

#### Solution: multi-hop networks

- Send packets to an intermediate node
- Intermediate node forwards packet to its destination
- **Store-and-forward** multi-hop network
- Basic technique applies to both WSN and MANET

#### Note:

- Store-and-forward multi-hopping NOT the only possible solution
  - Ex: Collaborative networking, Network coding [11] [12]....

## Single-hop vs. Multi-hop Networks



Single-hop networks

Multi-hop networks



## Multiple Sinks, Multiple Sources WSN





- MANETs are supposed to deliver bits from one end to the other
- WSNs, on the other end, are expected to provide information, not necessarily original bits
  - Ex: *manipulate* or *process* the data in the network
- Main example: aggregation
  - Apply composable [13] aggregation functions to a convergecast tree in a network
  - Typical functions: minimum, maximum, average, sum, ...

## In-network Processing

#### Processing Aggregation example

- The simplest in-network processing technique
- Reduce number of transmitted bits/packets by applying an aggregation function in the network

Data



## Gateway concepts for WSN/MANET

- Gateways are necessary to the Internet for remote access to/from the WSN
  - For ad hoc networks
    - Additional complications due to mobility
      - □ Ex: Change route to the gateway, use different gateways
  - For WSN
    - Additionally bridge the gap between different interaction semantics in the gateway

## Gateway concepts for WSN/MANET

• Gateway support for different radios/protocols, ...



## WSN to Internet communication

- Scenario: Deliver an alarm message to an Internet host
- Problems
  - Need to find a gateway (integrates routing & service discovery)
  - Choose "best" gateway if several are available
  - How to find John or John's IP address?



## Internet to WSN communication

- How to find the right WSN to answer a need?
- How to translate from IP protocols to WSN protocols, semantics?



## WSN Tunneling

- The idea is to build a larger, "Virtual" WSN
- Use the Internet to "tunnel" WSN packets between two remote WSNs



## WSN Tunneling

#### Example of WSN tunneling

• WSNs Testbed



## WSN tunneling

#### Example of WSN tunneling

Testbed scenario



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# 2.5. Challenges of Sensor Nodes
# Challenges of Wireless Sensor Node

- More energy-efficient
  - Self-sufficiency in power supply such as the installation of solar collector panels
  - Design more energy-efficient of the circuit, or to adopt more energyefficient electronic components
- Integrating more sensors
  - For multiple purposes such as detecting human's motion, temperature, blood pressure and heartbeat at the same time
- Higher processing performance
  - In future, more complex application need more powerful computation

# Challenges of Wireless Sensor Node

#### More Robust and Secure

- Not easy damaged or be destroyed
- Secure transmission of sensing data and not easy being tapped

#### • Easy to buy and deployment

• Low price and easy to use

# 2.6. Summary

# Summary

- For WSN, the need to build cheap, low-energy, (small) devices has various consequences for system design
  - Radio front ends and controllers are much simpler than in conventional mobile networks
  - Energy supply and scavenging are still (and for the foreseeable future) a premium resource
  - Power management (switching off or throttling down devices) crucial
- Unique programming challenges of embedded systems
  - Concurrency without support, protection
  - Lack of standard

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